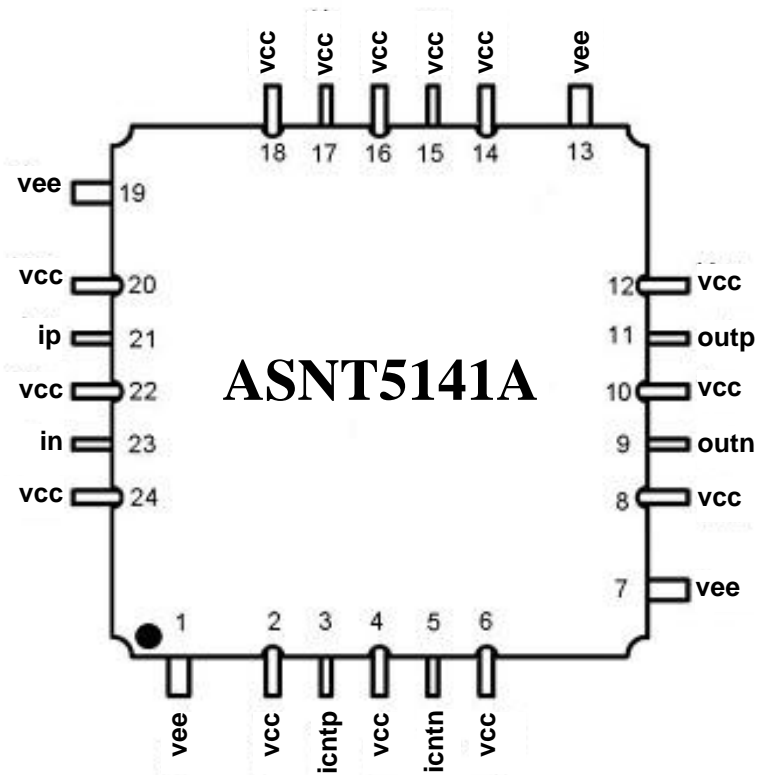




## ASNT5141A-KMC 6-35GHz Frequency Doubler

- High speed frequency doubler
- Exhibits low jitter and limited temperature variation over industrial temperature range
- Ideal for high speed proof-of-concept prototyping
- Fully differential CML input interfaces
- Fully differential CML output interface with 600mV single-ended swing
- Single +3.3V or -3.3V power supply
- Power consumption: 545mW
- Fabricated in SiGe for high performance, yield, and reliability
- Custom CQFP 24-pin package



## DESCRIPTION

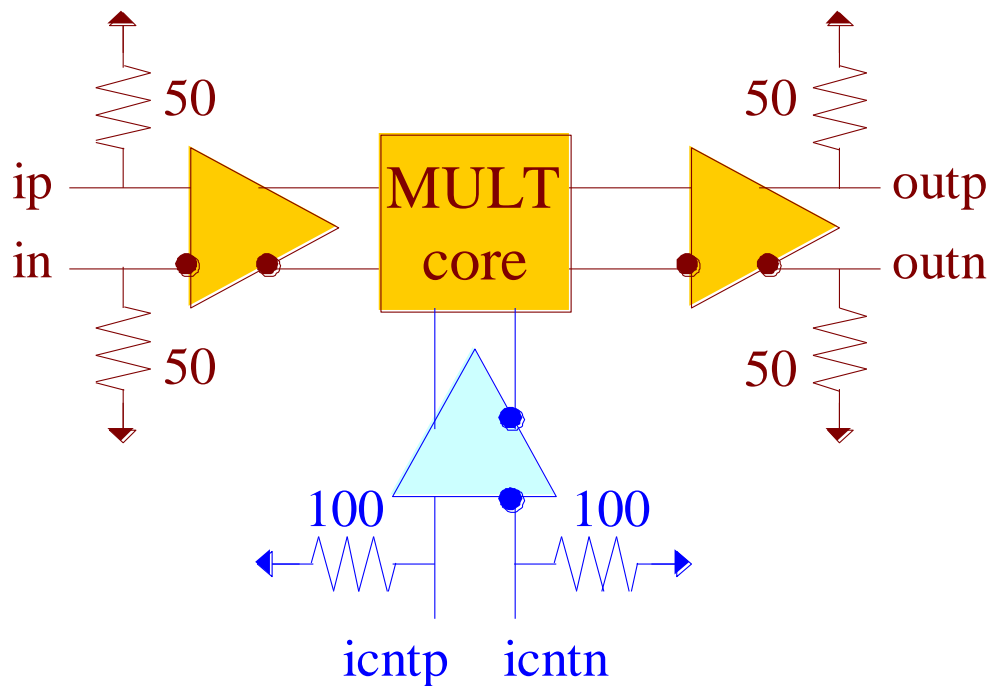


Fig. 1. Functional Block Diagram

The temperature stable ASNT5141A-KMC SiGe IC provides broadband frequency multiplication, and is intended for use in high-speed measurement / test equipment. The IC shown in Fig. 1 can receive a high-speed clock input signal **ip/in** and deliver a high-speed double frequency clock output signal **outp/outn** with its internal multiplication core while controlling its duty cycle via tuning port **icntp/icntn**.

The part's I/O's support the CML logic interface with on chip  $50\Omega$  termination to **vcc** and may be used differentially, AC/DC coupled, single-ended, or in any combination (also see POWER SUPPLY CONFIGURATION). In the DC-coupling mode, the input signal's common mode voltage should comply with the specifications shown in ELECTRICAL CHARACTERISTICS. In the AC-coupling mode, the input termination provides the required common mode voltage automatically. The differential DC signaling mode is recommended for optimal performance.

## POWER SUPPLY CONFIGURATION

The part can operate with either negative supply (**vcc** = 0.0V = ground and **vee** = -3.3V), or positive supply (**vcc** = +3.3V and **vee** = 0.0V = ground). In case of the positive supply, all I/Os need AC termination when connected to any devices with  $50\Omega$  termination to ground. Different PCB layouts will be needed for each different power supply combination.

**All the characteristics detailed below assume **vcc** = 0.0V and **vee** = -3.3V.**



## ABSOLUTE MAXIMUM RATINGS

Caution: Exceeding the absolute maximum ratings shown in Table 1 may cause damage to this product and/or lead to reduced reliability. Functional performance is specified over the recommended operating conditions for power supply and temperature only. AC and DC device characteristics at or beyond the absolute maximum ratings are not assumed or implied. All min and max voltage limits are referenced to ground (assumed vcc).

Table 1. Absolute Maximum Ratings.

Parameter	Min	Max	Units
Supply Voltage (vee)		-3.6	V
Power Consumption		0.60	W
RF Input Voltage Swing (SE)		1.0	V
Case Temperature		+90	°C
Storage Temperature	-40	+100	°C
Operational Humidity	10	98	%
Storage Humidity	10	98	%

## TERMINAL FUNCTIONS

TERMINAL			DESCRIPTION
Name	No.	Type	
<b>High-Speed I/Os</b>			
ip	21	CML input	Differential clock inputs with internal SE 500hm termination to vcc
in	23		
outp	11	CML output	Differential clock outputs with internal SE 500hm termination to vcc. Require external SE 500hm termination to vcc
outn	9		
icntp	3	CML input	Differential tuning ports with internal 1000hm termination to vcc
icntn	5		
<b>Supply and Termination Voltages</b>			
Name	Description		Pin Number
vcc	Positive power supply (+3.3V or 0)		2, 4, 6, 8, 10, 12, 14, 15, 16, 17, 18, 20, 22, 24
vee	Negative power supply (0V or -3.3V)		1, 7, 13, 19



## ELECTRICAL CHARACTERISTICS

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
<b>General Parameters</b>					
vee	-3.1	-3.3	-3.5	V	±6%
vcc		0.0		V	External ground
Ivee		165		mA	
Power consumption		545		mW	
Junction temperature	-40	25	125	°C	
<b>HS Input Clock (ip/in)</b>					
Frequency	3		17.5	GHz	
Swing	0.05		1.0	V	Differential or SE, p-p
CM Voltage Level	vcc-0.8		vcc	V	Must match for both inputs
<b>HS Output Clock (outp/outn)</b>					
Frequency	6		35	GHz	
Logic "1" level		vcc		V	
Logic "0" level		vcc-0.6		V	With external 50Ohm DC termination
Rise/Fall times	6	8	10	ps	20%-80%
Output Jitter			1	ps	Peak-to-peak
Duty cycle	45	50	55	%	For clock signal
<b>Tuning port (icntp/icntn)</b>					
Bandwidth	DC		100	MHz	
Swing		vcc-0.4		V	Differential
CM Voltage Level	vcc-0.4		vcc	V	Must match for both inputs

## PACKAGE INFORMATION

The chip die is housed in a custom 24-pin CQFP package shown in Fig. 2. The package provides a center heat slug located on its back side to be used for heat dissipation. ADSANTEC recommends for this section to be soldered to the vcc plain, which is ground for a negative supply, or power for a positive supply.

The part's identification label is ASNT5141A-KMC. The first 9 characters of the name before the dash identify the bare die including general circuit family, fabrication technology, specific circuit type, and part version while the 3 characters after the dash represent the package's manufacturer, type, and pin out count.

This device complies with the Restriction of Hazardous Substances (RoHS) per 2011/65/EU for all ten substances.

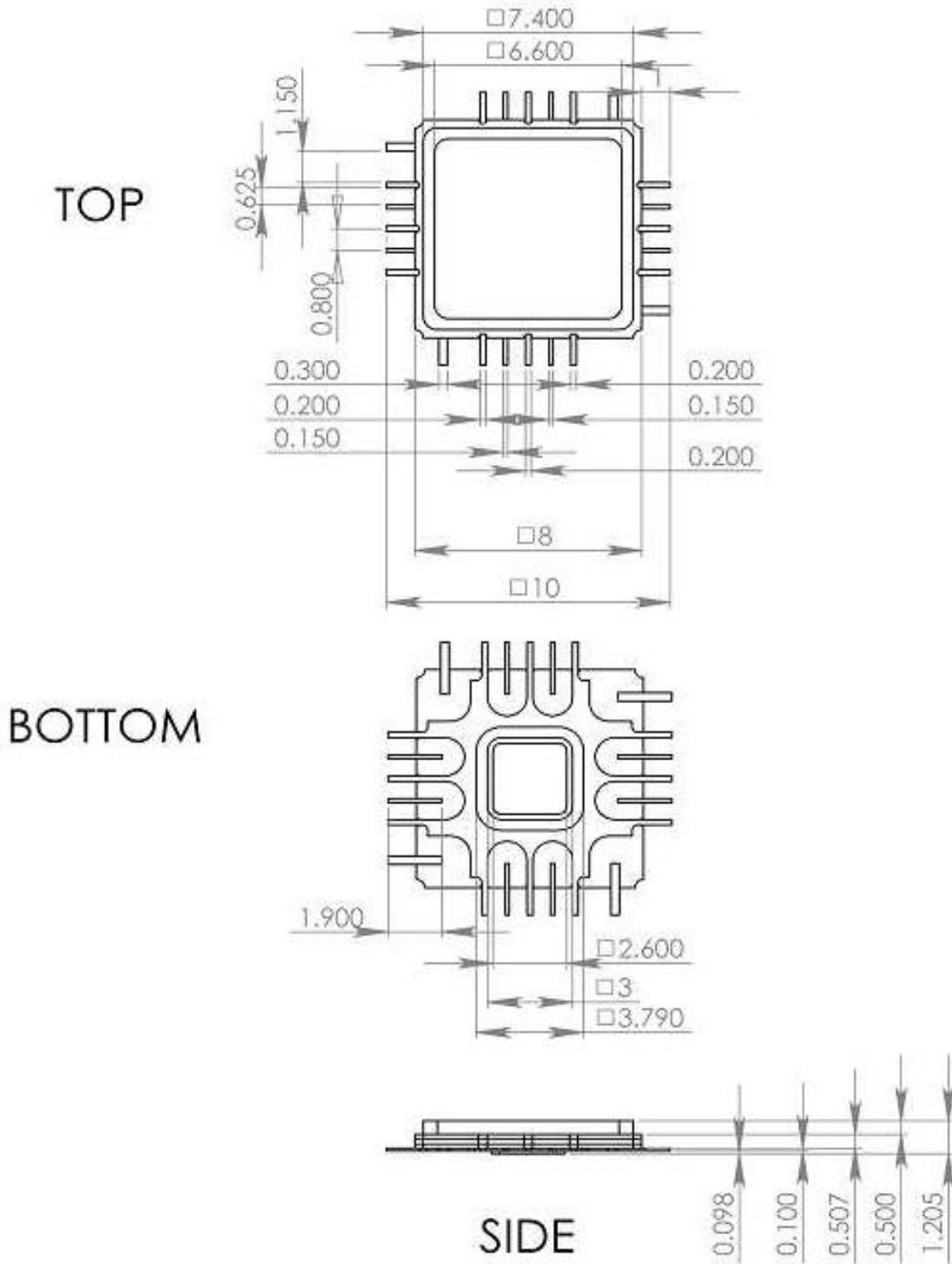


Fig. 2. CQFP 24-Pin Package Drawing (All Dimensions in mm)



## REVISION HISTORY

Revision	Date	Changes
1.1.2	06-2020	Corrected title Corrected minimum frequency
1.0.2	02-2020	Initial release
0.0.2	02-2020	Updated Package Information
0.0.1	01-2020	Preliminary release